

## Varistor

## **Material Data Sheet**

| V di liotoi                               |                      |                |   |   |                                   | •   | natorial Bata                         | •••           |
|---|----------------------|----------------|---|---|-----------------------------------|---|---------------------------------------|---------------|
| Product Class:                            |                      | House<br>B722x | d varistor<br>xT*                       |   |                                   |   |                                       |               |
| Date                                      |                      | 30.09.2        | 2019                                    |   |                                   |   |                                       |               |
| IMDS ID<br>if available                   |                      |                |   |   |                                   |   |                                       |               |
| Version                                   |                      | 5.06           |   |   |                                   |   |                                       |               |
| Product Part<br>(IMDS: semi<br>component) | Materia<br>(IMDS: Ma |                | Material<br>(Classification)<br>VDA 231 | Substance   | TMPS**)<br>[wt%]                  | CAS<br>if applicable  | typical mass of<br>material<br>[wt-%] | Traces see 1) |
| Active Part                               | ive Part Ceramic     |                | 3В                                      | ZnO<br>Bi2O3<br>Sb2O3<br>Co3O4<br>NiO<br>others*) | 91<br>4,0<br>2,5<br>1<br>0,5<br>1 | 1314-13-2<br>1304-76-3<br>1309-64-4<br>1308-06-1<br>1313-99-1 | 43,0                                  |               |

| Active Part                       | Ceramic                     | 3B                            | Co3O4<br>NiO<br>others*)   |                 | 2,5<br>1<br>0,5<br>1                    | 1308-06-1<br>1313-99-1  | 43,0  |  |
|-----------------------------------|-----------------------------|-------------------------------|--|-----------------|---|---|---|--|
| Termination                       | Composite                   | 4D                            | Cu or<br>Ag  |                 | 95 7440-50-8<br>7440-22-4               |   | 0,6   |  |
|                                   |                             |                               | Glass frit (boro-silicat   | ie)             | 5                                       |   |   |  |
| High melting<br>point solder      | Heavy Metal                 | 1C8                           | Sn<br>Ag<br>Cu   |                 | 96,5<br>3<br>0,5                        | 7440-31-5<br>7440-22-4<br>7440-50-8                               | 1,2   |  |
| Low melting<br>point solder       | Heavy Metal                 | 1C8                           | Sn<br>Bi   |                 | 42<br>58                                | 7440-31-5<br>7440-69-9  | 0,2   |  |
|                                   |                             | 1C12                          | Cu   |                 | 100                                     | 7440-50-8   | 6,0   |  |
| Leads                             | Heavy Metal 1C8 Sn          |                               |  | 100             | 7440-31-5                               | 0,2   |   |  |
| Spring                            | Heavy Metal                 | 1C12                          | Cu<br>Sn<br>P  |                 | 92,75<br>7,0<br>0,25                    | 7440-50-8<br>7440-31-5<br>7723-14-0                               | 3,2   |  |
|                                   |                             | 1C8                           | Sn   |                 | 100                                     | 7440-31-5   | 0,2   |  |
| Encapsulation                     | Duromer                     | 2D<br>Halogen-free<br>coating | SiO2<br>Epoxy<br>Pyromellitic dianhydride<br>Phosphated epoxy<br>others*)  |                 | 46<br>40<br>6,5<br>5<br>2,5             | 60676-86-0<br>25036-25-3<br>89-32-7                               | 7,9   |  |
| Plastic<br>housing inner<br>cover | Thermoplastic               | 2A                            | Aromatic Liquid Crystal Polymer (LCP)<br>Glass fiber<br>others*)   |                 | 68<br>30<br>2                           | 147310-94-9   | 12,8  |  |
| Plastic<br>housing outer<br>cover | Thermoplastic               | 2A                            | Poly butylene terephthalate (PBT)<br>Glass fiber<br>Brominated flame retardant 1<br>Brominated flame retardant 2<br>Sb2O3<br>Other*) |                 | 68<br>16,2<br>6<br>6<br>3<br>0,8        | 24968-12-5<br>65997-17-3<br>68928-70-1<br>71342-77-3<br>1309-64-4 | 24,7  |  |
|                                   |                             |                               |  |                 |   | Sum in total:   | 100   |  |
| sizes L x W [mm]<br>21,6 X 17     | weight range [g]<br>3,8-5,5 |                               |  |                 | weight range [g]<br>5,8-8.8<br>9,9-18,0 | material numbe<br>B72220T*<br>B72220T                             | er part numbers<br>T20K50-K420*<br>T20K460-K1000* |  |
| Not part of a Pro                 | oduct Class T20             | )K50DF (B72220T050            | 0K105) and T20K510N  | 110K4 (B72220T0 | 511K109) is n                           | ot a part of this p   | roduct class.                                     |  |



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| Product Class:          | Housed Varistor<br>B722xxT* |
|-------------------------|-----------------------------|
| Date                    | 30.09.2019                  |
| IMDS ID<br>if available |                             |
| Version:                | 5.06                        |

| Contact  | Mr. Christoph Ronner   |                            | Important remarks:  |   |  |  |  |  |
|--|--|----------------------------|---|---|--|--|--|--|
| Division   | PPD Q QM   |                            | 1)  | The declaration limit is 0.1% as defined by IEC 62474 (IEC PAS 61906). Traces an  |  |  |  |  |
| Address  | 8530 Deutschlandsberg, AUSTRIA   |                            |   | product parts, substances etc. that are below a percentage of 0.1 % by weight, if<br>otherwise regulated.   |  |  |  |  |
|  | Tel: +43 3462 800 2139 mailto: functional.ppd-eqpm.db@tdk-electronics.tdk.com  |                            | 2)  | This Material Data Sheet contains typical values of the respective products set for   |  |  |  |  |
| *) others: .(not   | t declarable or prohibit   | ted substances acc. GADSL) |   | herein. We expressly point out that all values and statements contained herein are<br>based on our best present knowledge and cannot be regarded as binding statements                            |  |  |  |  |
| **) typical mass percentage of substance   |  |                            | or binding product specifications, unless otherwise explicitly agreed in writing. TDK<br>ELECTRONICS AG AND ITS AFFILIATES HEREBY EXPRESSLY DISCLAIM ANY<br>REPRESENTATION OR WARRANTY, WHETHER EXPRESS, IMPLIED OR<br>STATUTORY, WITH REGARD TO THE STATEMENTS AND VALUES CONTAINED<br>HEREIN, INCLUDING BUT NOT LIMITED TO ANY REPRESENTATION OR<br>WARRANTY OF MERCHANTABILITY OR SUITABILITY FOR ANY PURPOSE. |   |  |  |  |  |
| of Directive 201   | 1/65/EU of the European  |                            | the re  | roducts are compatible with the requirements according to Art. 4 (substance restrictions)<br>striction of the use of certain hazardous substances in electrical and electronic equipment.<br>alid |  |  |  |  |
| ☑ no exemption:  | ,  |                            |   |   |  |  |  |  |
| Exemption 6 (a)  | a): Lead as an alloying element in steel for machining purposes and in galvanized steel containing up to 0,35 % lead by weight;  |                            |   |   |  |  |  |  |
| Exemption 6 (b)  | <li>Lead as an alloying element in aluminium containing up to 0,4 % lead by weight;</li>   |                            |   |   |  |  |  |  |
| Exemption 6 (c)  | Exemption 6 (c): Copper alloy containing up to 4 % lead by weight;   |                            |   |   |  |  |  |  |
| Exemption 7 (a)  | 3 Exemption 7 (a): Lead in high melting temperature type solder (i.e. lead-based alloys containing 85 % by weight or more lead);   |                            |   |   |  |  |  |  |
| Exemption 7 (c)  | Exemption 7 (c)-1: Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound; |                            |   |   |  |  |  |  |
| Examplian 7 (a) III. Load in disloction corrections for a rotatively or 125 VAC or 250 V |  |                            |   |   |  |  |  |  |

Exemption 7 (c)-II: Lead in dielectric ceramic in capacitors for a rated voltage of 125 V AC or 250 V DC or higher;

Exemption 7 (c)-III: Lead in dielectric ceramic in capacitors for a rated voltage of less than 125 V AC or 250 V DC;

Exemption 15: Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit Flip Chip packages;

Other Exemption than above ......